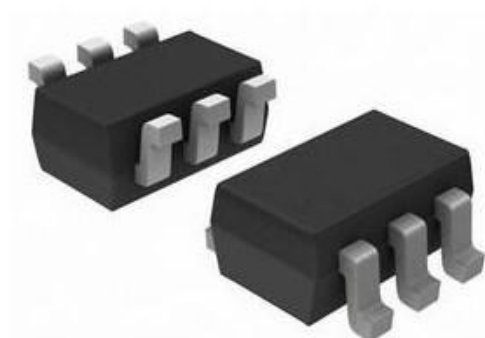


»Features

- 60Watts peak pulse power ($t_p = 8/20\mu s$)
- SOT563 package
- Solid-state silicon-avalanche technology
- Low clamping voltage
- Low leakage current
- Low capacitance ($C_j = 0.25pF$ typ.)
- Protection one data/power line
- IEC 61000-4-2 $\pm 15kV$ contact $\pm 20kV$ air
- IEC 61000-4-4 (EFT) 40A (5/50ns)
- IEC 61000-4-5 (Lightning) 3.5A (8/20 μs)



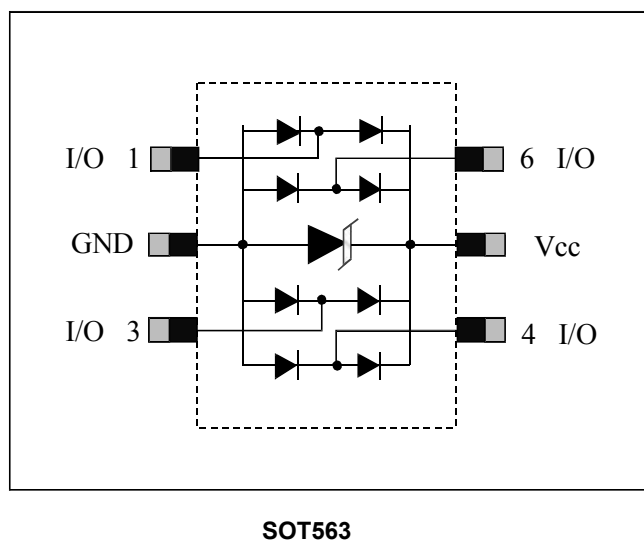
»Applications

- Ethernet
- Digital Visual Interface (DVI)
- USB2.0
- Notebook and PC Computers

»Mechanical Data

- SOT563 package
- Molding compound flammability rating: UL 94V-0
- Packaging: Tape and Reel
- RoHS/WEEE Compliant

»Schematic & PIN Configuration



»Absolute Maximum Rating

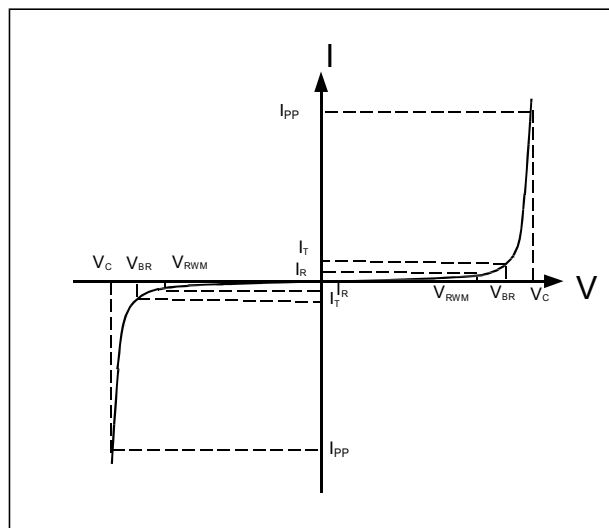
Rating	Symbol	Value	Units
Peak Pulse Power ($t_p = 8/20\mu s$)	P_{PP}	60	Watts
Peak Pulse Current ($t_p = 8/20\mu s$)(note1)	I_{pp}	3.5	A
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V_{ESD}	20 15	kV
Lead Soldering Temperature	T_L	260(10seconds)	$^{\circ}C$
Junction Temperature	T_J	-55 to + 125	$^{\circ}C$
Storage Temperature	T_{stg}	-55 to + 125	$^{\circ}C$

»Electrical Characteristics

Parameter	Symbol	Conditions	Min	Typical	Max	Units
Reverse Stand-Off Voltage	V_{RWM}				5.0	V
Reverse Breakdown Voltage	V_{BR}	$I_T = 1mA$	6			V
Reverse Leakage Current	I_R	$V_{RWM} = 5V, T = 25^{\circ}C$		50	500	nA
Peak Pulse Current	I_{pp}	$t_p = 8/20\mu s$			3	A
Clamping Voltage	V_C	$I_{pp} = 3.5A, t_p = 8/20\mu s$		15	18	V
Junction Capacitance	C_j	$V_R = 0V, f = 1MHz$ IO to IO		0.2	0.25	pF
		$V_R = 0V, f = 1MHz$ IO to GND		0.35	0.5	

»Electrical Parameters (TA = 25°C unless otherwise noted)

Symbol	Parameter
I_{PP}	Maximum Reverse Peak Pulse Current
V_C	Clamping Voltage @ I_{PP}
V_{RWM}	Working Peak Reverse Voltage
I_R	Maximum Reverse Leakage Current @ V_{RWM}
V_{BR}	Breakdown Voltage @ I_T
I_T	Test Current



Note: 8/20 μs pulse waveform.

»Typical Characteristic Curves

Fig.1 Peak Pulse Power Rating Curve

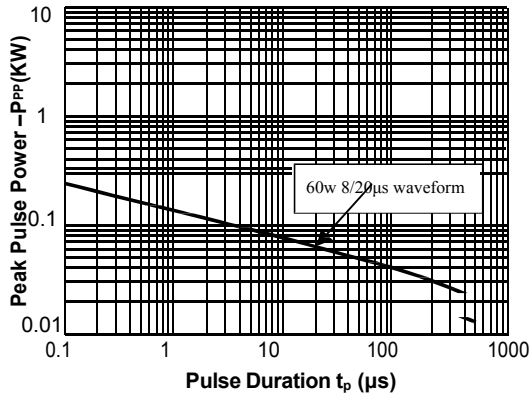


Fig.2 Pulse Derating Curve

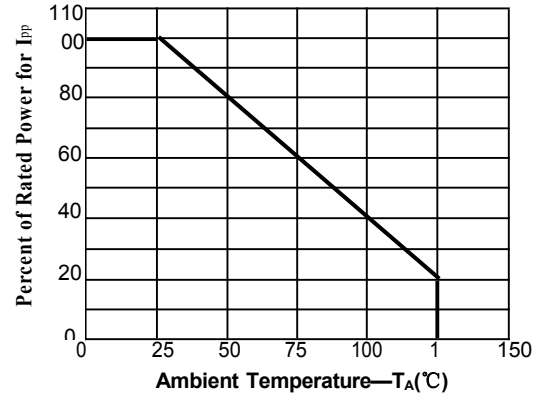


Fig.3 PulseWaveform-8/20μs

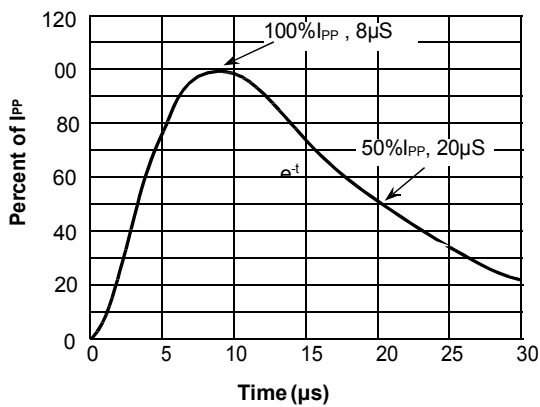


Fig.4 PulseWaveform-ESD(IEC61000-4-2)

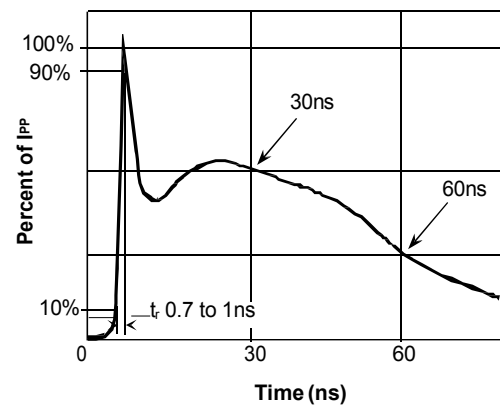


Fig.5 Eye Diagram - HDMI mask at 5.0Gbpsper channel

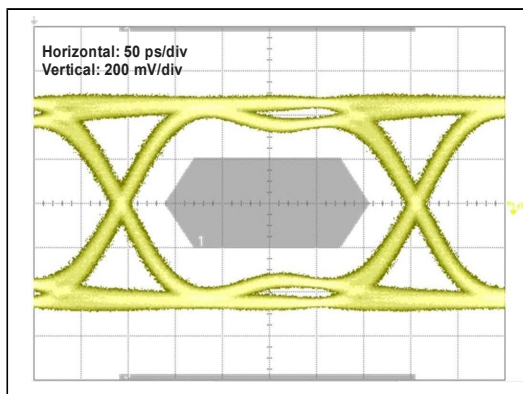
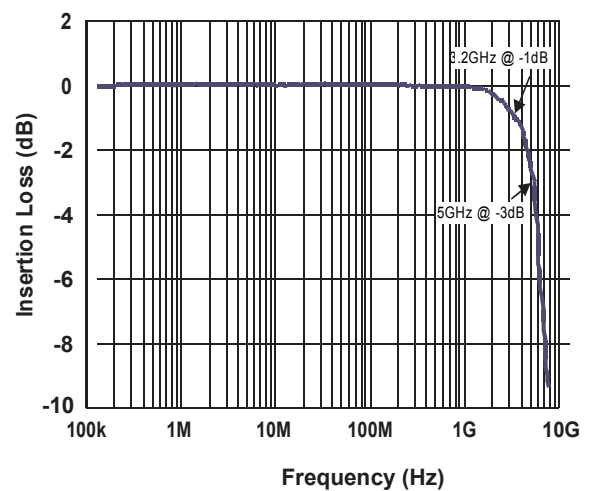
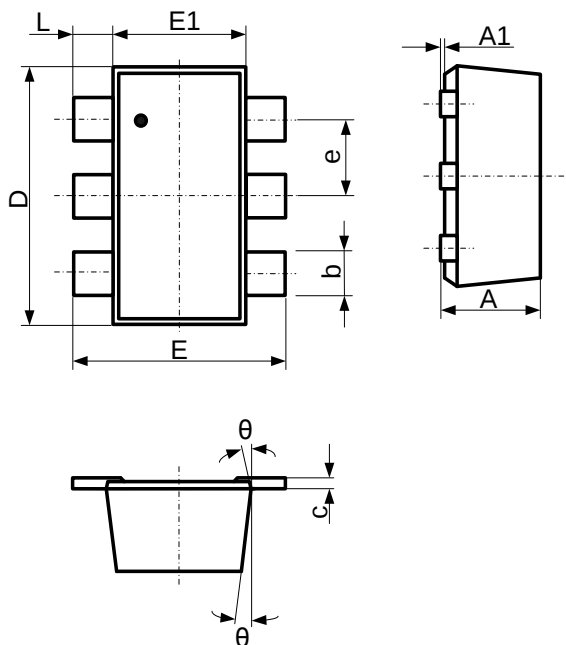


Fig.6 Insertion Loss S21 - I/O to GND

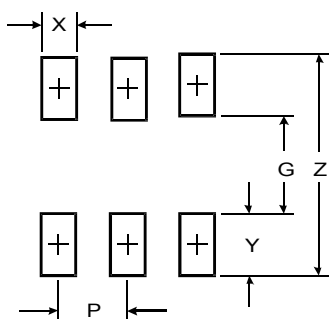


»Outline Drawing – SOT563

PACKAGE OUTLINE

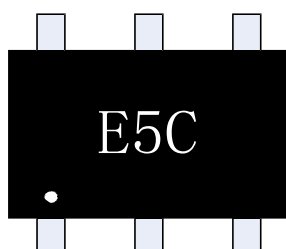


SYMBOL	DIMENSIONS			
	INCHES		MILLIMETER	
	MIN	MAX	MIN	MAX
A	0.021	0.024	0.525	0.600
A1	0.000	0.002	0.000	0.050
e	0.018	0.022	0.450	0.550
c	0.004	0.006	0.090	0.160
D	0.059	0.067	1.500	1.700
b	0.007	0.011	0.170	0.270
E1	0.043	0.051	1.100	1.300
E	0.059	0.067	1.500	1.700
L	0.004	0.012	0.100	0.300
θ	7°REF		7°REF	



DIMENSIONS		
DIM	INCHES	MILLIMETERS
Z	0.0752	1.91
G	0.0350	0.89
P	0.020TYP	0.51 TYP
X	0.0118	0.3
Y	0.0201	0.51

»Marking



Ordering information

Order code	Package	Base qty	Delivery mode
BNSP3004-04XTG	SOT563	3k	Tape and reel